### Silicon N-Channel Dual Gate MOS FET

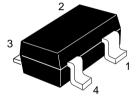
# **HITACHI**

#### **Application**

VHF/UHF TV tuner RF amplifier

#### Outline

MPAK-4



- 1. Source
- 2. Gate1
- 3. Gate2
- 4. Drain



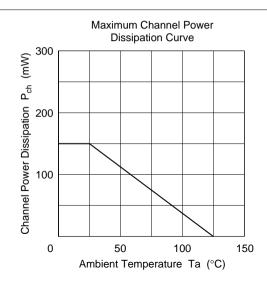
### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

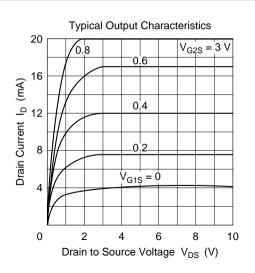
Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DS}$	15	V
Gate 1 to source voltage	$V_{G1S}$	±10	V
Gate 2 to source voltage	$V_{\rm G2S}$	±10	V
Drain current	$I_{D}$	35	mA
Channel power dissipation	Pch	150	mW
Channel temperature	Tch	125	°C
Storage temperature	Tstg	-55 to +125	°C

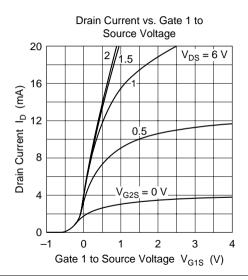
### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

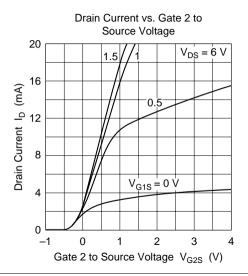
voltage	(BK)G133	15 ±10 ±10	<del>-</del>	_	V	$I_D = 200 \mu A,$ $V_{G1S} = V_{G2S} = -5 V$
			_	_		
	(BR)G2SS	<b>±10</b>			V	$I_{G1} = \pm 10 \ \mu A, \ V_{G2S} = V_{DS} = 0$
Gate 2 to source breakdown $V_{(\epsilon)}$ voltage		±10	_	_	V	$I_{G2} = \pm 10 \ \mu A, \ V_{G1S} = V_{DS} = 0$
Gate 1 cutoff current I <sub>G1</sub>	188	_	_	±100	nA	$V_{G1S} = \pm 8 \text{ V}, V_{G2S} = V_{DS} = 0$
Gate 2 cutoff current I <sub>G2</sub>	2SS	_	_	±100	nA	$V_{G2S} = \pm 8 \text{ V}, V_{G1S} = V_{DS} = 0$
Gate 1 to source cutoff voltage V <sub>c</sub>	G1S(off)	_	-	-1.0	V	$V_{DS} = 10 \text{ V}, V_{G2S} = 3 \text{ V},$ $I_{D} = 100 \mu\text{A}$
Gate 2 to source cutoff voltage V <sub>c</sub>	G2S(off)	_	_	-1.5	V	$V_{DS} = 10 \text{ V}, V_{G1S} = 3 \text{ V},$ $I_{D} = 100 \mu\text{A}$
Drain current I <sub>DS</sub>	SS	0	_	10	mA	$V_{DS} = 6 \text{ V}, V_{G1S} = 0, V_{G2S} = 3 \text{ V}$
Forward transfer admittance  y,	fs	17	_	_	mS	$V_{DS} = 6 \text{ V}, V_{G2S} = 3 \text{ V},$ $I_{D} = 10 \text{ mA}, f = 1 \text{ kHz}$
Input capacitance Ci	iss	_	2.8	3.5	pF	$V_{DS} = 6 \text{ V}, V_{G2S} = 3 \text{ V},$ $I_{D} = 10 \text{ mA}, f = 1 \text{ MHz}$
Output capacitance Co	oss	_	1.8	2.5	pF	
Reverse transfer capacitance Cr	rss		0.02	_	pF	
Power gain PC	G	12	15	_	dB	$V_{DS} = 6 \text{ V}, V_{G2S} = 3 \text{ V},$ $I_{D} = 10 \text{ mA}, f = 900 \text{ MHz}$
Noise figure NF	F	_	3.0	4.5	dB	
Noise figure NF	F	_	3.0	4.0	dB	$V_{DD} = 12 \text{ V}, V_{AGC} = 10.5 \text{ V},$ f = 60 MHz
Power gain PC	G	27	30	_	dB	$V_{DS} = 6 \text{ V}, V_{G2S} = 3 \text{ V},$ $I_{D} = 10 \text{ mA}, f = 200 \text{ MHz}$
Noise figure NF	F	_	1.0	2.5	dB	

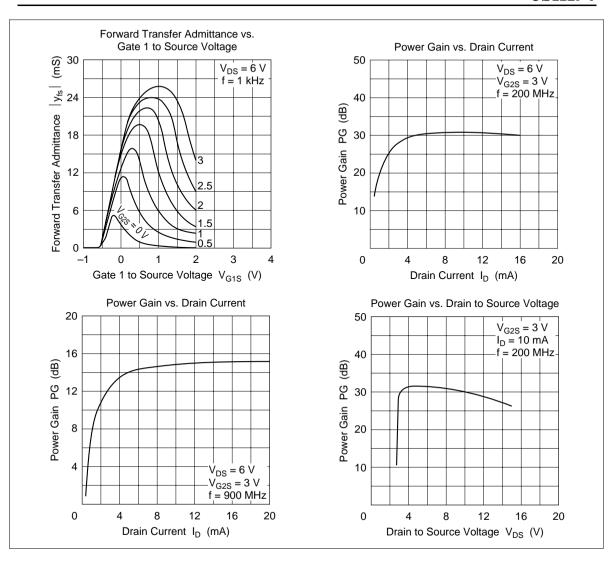
Note: Marking is "IY-".

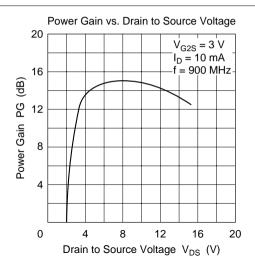


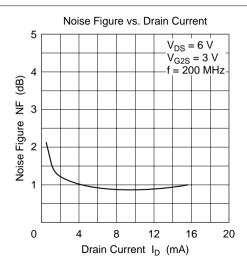


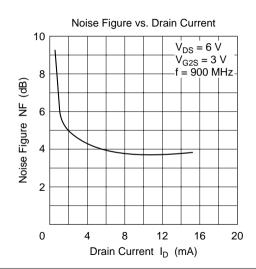


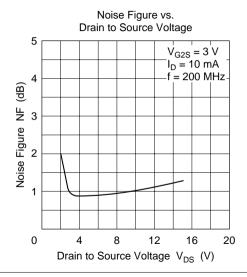


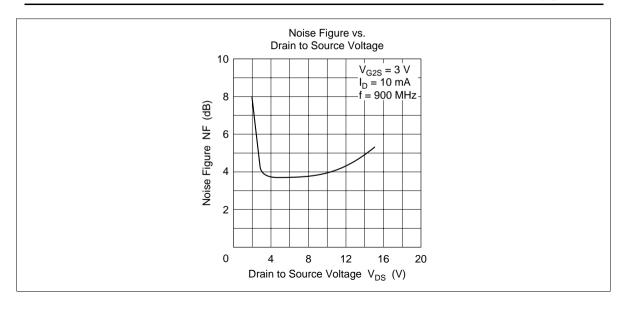




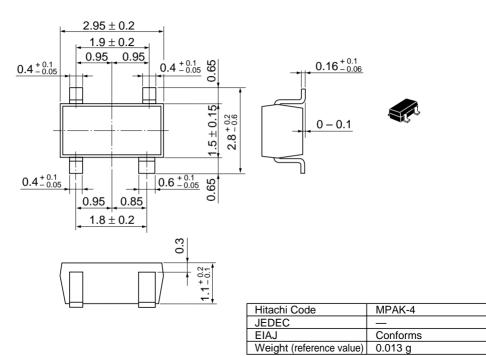








Unit: mm



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